

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10568616			
<b>Filing Date:</b>	16-Feb-2006			
<b>Title of Invention:</b>	Curing composition with improved heat resistance			
<b>First Named Inventor/Applicant Name:</b>	Toshihiko Okamoto			
<b>Filer:</b>	Sheldon Irving Landsman/Carolyn Tavernese			
<b>Attorney Docket Number:</b>	Q93069			
Filed as Large Entity				
<b>U.S. National Stage under 35 USC 371 Filing Fees</b>				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
Post-Allowance-and-Post-Issuance:				
<b>Extension-of-Time:</b>				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Submission- Information Disclosure Stmt	1806	1	180	180
Total in USD (\$)				180